



**Part Number :** [15800309](#)

**Product Description :** 2.54mm Pitch C-Grid Header, Through Hole without Peg, Dual Row, Vertical, Shrouded, High Temperature, 30 Circuits, 0.38µm Gold (Au) Selective Plating, Tin (Sn) PC Tail Plating, 3.81mm Inside Shroud to End Circuit Spacing

**Series Number :** 70567

**Status :** Active

**Product Category :** PCB Headers and Receptacles

**Engineering Part Number :** A-70567-0285

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## Documents and Resources

### Drawings

[015800309\\_sd.pdf](#)

[PK-70873-0018-001.pdf](#)

### 3D Models and Design Files

[STEP AP242](#)

[SOLIDWORKS](#)

[Creo](#)

[Symbol and Footprint \(Multi-Format\)](#)


### Specifications

[PS-70567-001.pdf](#)

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## Product Environment Compliance

### Compliance

GADSL/IMDS	Not Relevant
China RoHS	 per SJ/T 11365-2006
EU ELV	Not Relevant
Low-Halogen Status	Low-Halogen per IEC 61249-2-21
REACH SVHC	Not Contained per D(2025)7771-DC (04 Feb 2026)
EU RoHS	Compliant per EU 2015/863

## Compliance Statements

- EU RoHS
- REACH SVHC
- Low-Halogen

## Industry Documents

- IPC 1752A Class C
- IPC 1752A Class D
- Molex Product Compliance Declaration
- IEC-62474
- chemSHERPA (xml)

## Substances of Interest

- PFAS

## EU RoHS Certificate of Compliance

## Additional Product Compliance Information

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## Part Details

### General

Status	Active
Category	PCB Headers and Receptacles
Series	70567
Description	2.54mm Pitch C-Grid Header, Through Hole without Peg, Dual Row, Vertical, Shrouded, High Temperature, 30 Circuits, 0.38µm Gold (Au) Selective Plating, Tin (Sn) PC Tail Plating, 3.81mm Inside Shroud to End Circuit Spacing
Application	Signal, Wire-to-Board
Component Type	PCB Header
Product Name	C-Grid
UPC	800755031294

### Agency

CSA	LR19980
UL	E29179

### Electrical

Current - Maximum per Contact	2.5A
Voltage - Maximum	250V DC

## Physical

Breakaway	No
Circuits (Loaded)	30
Circuits (maximum)	30
Color - Resin	Black
Durability (mating cycles max)	25
First Mate / Last Break	No
Flammability	94V-0
Glow-Wire Capable	No
Guide to Mating Part	No
Keying to Mating Part	No
Lock to Mating Part	Yes
Material - Metal	Brass, Phosphor Bronze
Material - Plating Mating	Gold
Material - Plating Termination	Tin
Material - Resin	High Temperature Thermoplastic
Net Weight	5.296/g
Number of Rows	2
Orientation	Vertical
Packaging Type	Tube
PCB Locator	No
PCB Retention	Yes
PCB Thickness - Recommended	2.36mm
PC Tail Length	3.30mm
Pitch - Mating Interface	2.54mm
Pitch - Termination Interface	2.54mm
Plating min - Mating	0.381µm
Plating min - Termination	1.905µm
Polarized to Mating Part	No
Polarized to PCB	No
Shrouded	Open Ends
Stackable	No

Temperature Range - Operating	-55° to +105°C
Termination Interface Style	Through Hole

### Solder Process Data

Max-Duration	5
Lead-Free Process Capability	SMC&WAVE
Max-Cycle	1
Max-Temp	245

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### Mates With / Use With

#### Mates with Part(s)

Description	Part Number
C-Grid Vertical, Dual Row, High Profile, Surface Mount PCB Connectors	<u>71395</u>
C-Grid Vertical, Dual Row, High Profile, Through Hole PCB Receptacles	<u>71850</u>
SL Dual Row Crimp Housings	<u>70450</u>

#### Use with Part(s)

Description	Part Number
2.54mm SL Interim Clips	<u>70013</u>

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